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N-Channel Shielded Gate PowerTrench[®] MOSFET 150 V, 2.8 A, 128 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 128 m Ω at V_{GS} = 10 V, I_D = 2.8 A
- Max $r_{DS(on)}$ = 178 m Ω at V_{GS} = 6 V, I_D = 2.4 A
- High Performance Trench Technology for Extremely Low ^rDS(on)
- High Power and Current Handling Capability in a Widely Used Surface Mount Package
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant



General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Primary Switch





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage			150	V
V _{GS}	Gate to Source Voltage			±20	V
1	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	2.8	•
I _D	-Pulsed			12	— A
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	12	mJ
D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.2	W
PD	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	12	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	55	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86244	FDT86244	SOT-223	13 "	12 mm	2500 units

January 2016

FDT86244
N-Channel S
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Shielded Gate PowerTrencl
∎ ®
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		104		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 2.8 A		106	128	
		$V_{GS} = 6 V, I_D = 2.4 A$		127	178	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.8 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		196	237	
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 2.8 A		12		S
Dynamic	Characteristics					
Ciss	Input Capacitance			295	395	pF
Coss	Output Capacitance	── V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		33	45	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 10112		2.4	5	pF
Rg	Gate Resistance			1.0		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			5.3	11	ns
t _r	Rise Time	$V_{DD} = 75 \text{ V}, I_D = 2.8 \text{ A},$		1.3	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9.8	20	ns
t _f	Fall Time			2.4	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		4.9	7	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V,$ $I_D = 2.8 A$		2.8	4	nC
Q _{gs}	Total Gate Charge	I _D = 2.0 A		1.4		nC
Q _{gd}	Gate to Drain "Miller" Charge			1.3		nC

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.8 A$ (Note 2)	0.82	1.3	V
t _{rr}	Reverse Recovery Time	I _F = 2.8 A, di/dt = 100 A/μs		48	77	ns
Q _{rr}	Reverse Recovery Charge	$r_F = 2.8 \text{ A}, \text{ di/dt} = 100 \text{ A/} \mu \text{s}$		44	70	nC

NOTES:

R_{θJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.







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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

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